

# Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

## eSMP® Series



Top View

Bottom View

### SlimSMA (DO-221AC)

Cathode  Anode

## FEATURES

- Very low profile - typical height of 0.95 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

## LINKS TO ADDITIONAL RESOURCES



## PRIMARY CHARACTERISTICS

|                               |                    |
|-------------------------------|--------------------|
| $I_{F(AV)}$                   | 3 A                |
| $V_{RRM}$                     | 60 V               |
| $I_{FSM}$                     | 80 A               |
| $V_F$ at $I_F = 3$ A (125 °C) | 0.41 V             |
| $T_J$ max.                    | 150 °C             |
| Package                       | SlimSMA (DO-221AC) |
| Circuit configuration         | Single             |

## TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

## MECHANICAL DATA

**Case:** SlimSMA (DO-221AC)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

**Polarity:** color band denotes cathode end

## MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)

| PARAMETER  | SYMBOL            | VSSAF3L63   | UNIT |
|--|-------------------|-------------|------|
| Device marking code  |                   | 3L63        |      |
| Maximum repetitive peak reverse voltage  | $V_{RRM}$         | 60          | V    |
| Maximum DC forward current   | $I_{F(AV)}^{(1)}$ | 2.5         | A    |
|  | $I_{F(AV)}^{(2)}$ | 3           |      |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | $I_{FSM}$         | 80          | A    |
| Operating junction temperature range   | $T_J^{(3)}$       | -40 to +150 | °C   |
| Storage temperature range  | $T_{STG}$         | -55 to +150 | °C   |

## Notes

(1) Free air, mounted on recommended copper pad area

(2) Mounted on 30 mm x 30 mm pad area

(3) The heat generated must be less than thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$

**ELECTRICAL CHARACTERISTICS** ( $T_J = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

| PARAMETER                     | TEST CONDITIONS        |                         | SYMBOL                        | TYP. | MAX. | UNIT |
|-------------------------------|------------------------|-------------------------|-------------------------------|------|------|------|
| Instantaneous forward voltage | I <sub>F</sub> = 1.5 A | T <sub>J</sub> = 25 °C  | V <sub>F</sub> <sup>(1)</sup> | 0.43 | -    | V    |
|                               | I <sub>F</sub> = 3 A   |                         |                               | 0.48 | 0.54 |      |
|                               | I <sub>F</sub> = 1.5 A | T <sub>J</sub> = 125 °C |                               | 0.33 | -    |      |
|                               | I <sub>F</sub> = 3 A   |                         |                               | 0.41 | 0.48 |      |
| Reverse current               | V <sub>R</sub> = 60 V  | T <sub>J</sub> = 25 °C  | I <sub>R</sub> <sup>(2)</sup> | -    | 0.07 | mA   |
|                               |                        | T <sub>J</sub> = 125 °C |                               | 3.5  | 8    |      |
| Typical junction capacitance  | 4.0 V, 1 MHz           |                         | C <sub>J</sub>                | 680  | -    | pF   |

**Notes**(1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle(2) Pulse test: pulse width  $\leq 5\text{ ms}$ **THERMAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise specified)

| PARAMETER                  | SYMBOL                   | VSSAF3L63 | UNIT                 |
|----------------------------|--------------------------|-----------|----------------------|
| Typical thermal resistance | $R_{\theta JA}^{(1)(2)}$ | 115       | $^{\circ}\text{C/W}$ |
|                            | $R_{\theta JM}^{(3)}$    | 12        |                      |

**Notes**(1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient(2) The heat generated must be less than thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ (3) Mounted on 30 mm x 30 mm pad area,  $R_{\theta JM}$  - junction to mount**ORDERING INFORMATION** (Example)

| PREFERRED P/N                 | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                      |
|-------------------------------|-----------------|------------------------|---------------|------------------------------------|
| VSSAF3L63-M3/H                | 0.032           | H                      | 3500          | 7" diameter plastic tape and reel  |
| VSSAF3L63-M3/I                | 0.032           | I                      | 14 000        | 13" diameter plastic tape and reel |
| VSSAF3L63HM3/H <sup>(1)</sup> | 0.032           | H                      | 3500          | 7" diameter plastic tape and reel  |
| VSSAF3L63HM3/I <sup>(1)</sup> | 0.032           | I                      | 14 000        | 13" diameter plastic tape and reel |

**Note**

(1) AEC-Q101 qualified

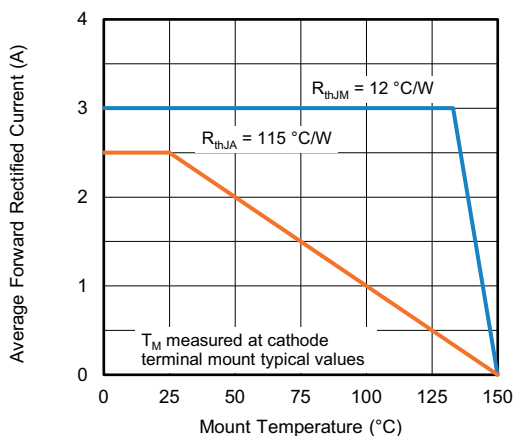
**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)


Fig. 1 - Maximum Forward Current Derating Curve

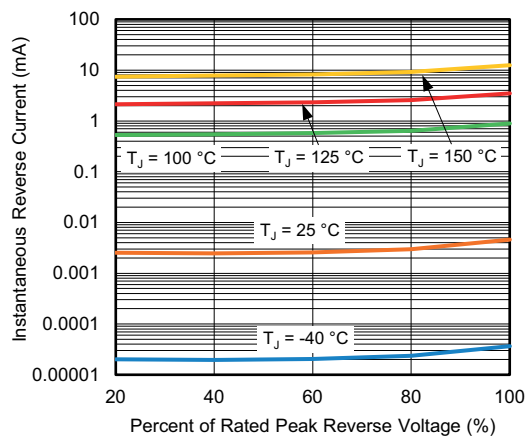


Fig. 4 - Typical Reverse Leakage Characteristics

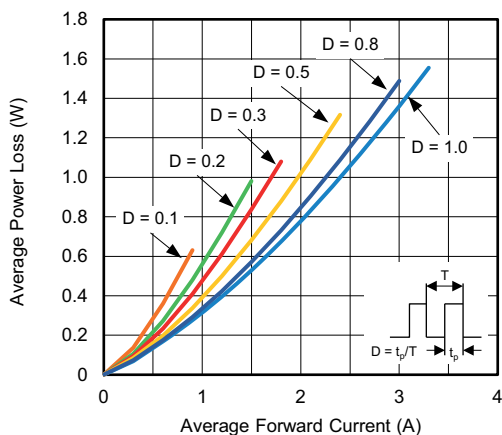


Fig. 2 - Forward Power Loss Characteristics

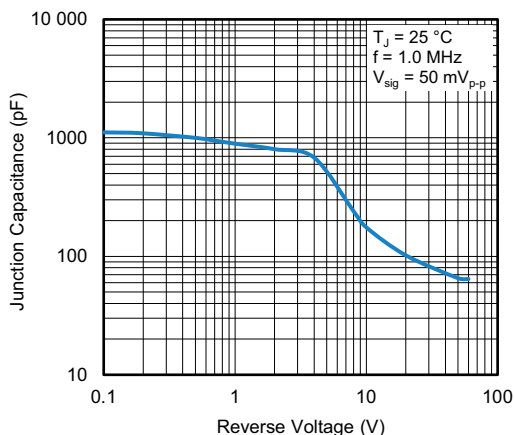


Fig. 5 - Typical Junction Capacitance

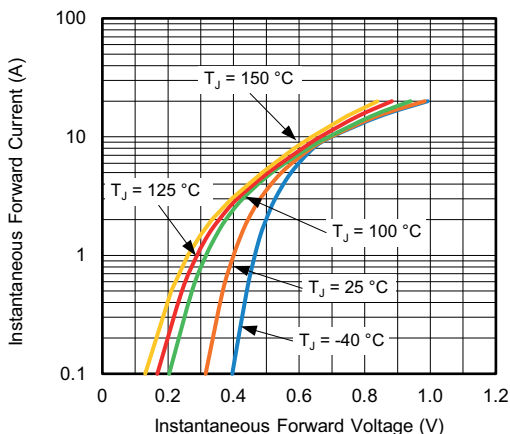


Fig. 3 - Typical Instantaneous Forward Characteristics

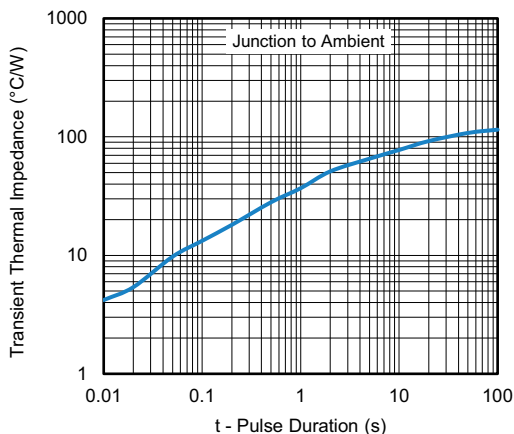


Fig. 6 - Typical Transient Thermal Impedance

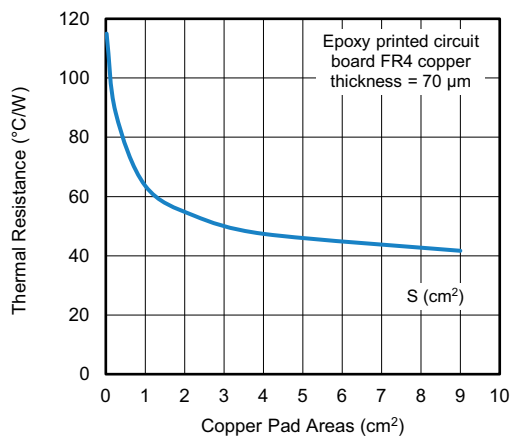
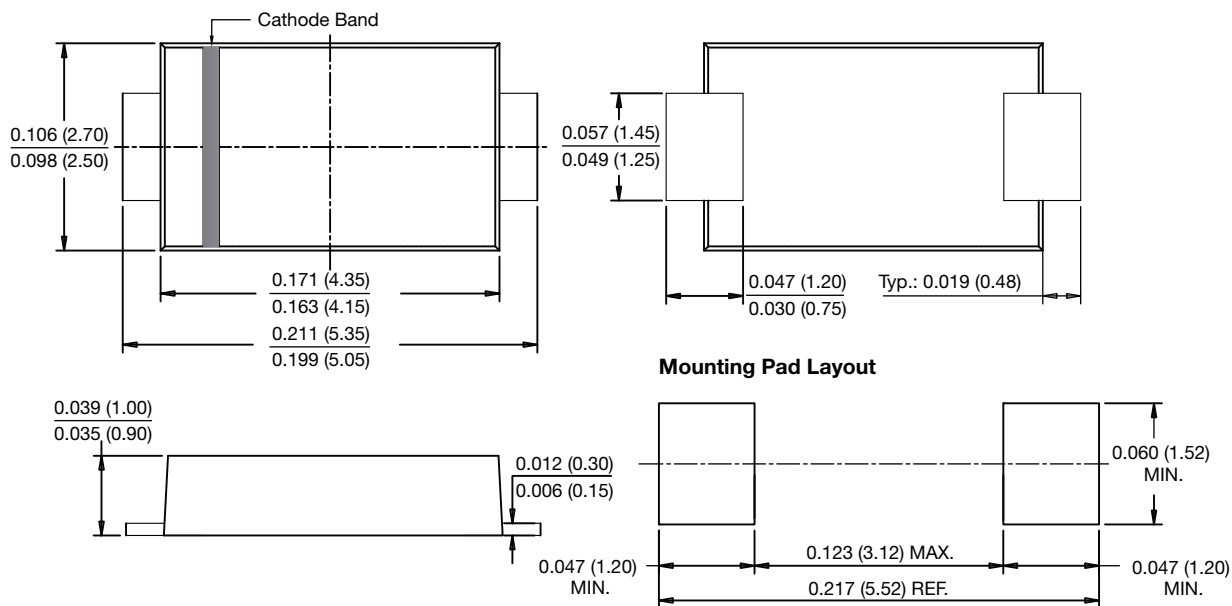


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Area

## PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

### SlimSMA (DO-221AC)





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